PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6639972

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JONG HYUN KIM	03/26/2021

RECEIVING PARTY DATA

Name:	SK HYNIX INC.
Street Address:	2091, GYEONGCHUNG-DAERO, BUBAL-EUB
City:	ICHEON-SI GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	17336

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17222505

CORRESPONDENCE DATA

Fax Number: (630)323-0335

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: WILLIAM PARK & ASSOCIATES LTD.

Address Line 1: 930 N. YORK ROAD, SUITE 201

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ATTORNEY DOCKET NUMBER:	PA4541-0	
IAME OF SUBMITTER: W. WILLIAM PARK		
SIGNATURE:	/W. William Park/	
DATE SIGNED:	04/05/2021	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT 506593169 REEL: 055826 FRAME: 0206

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

SHINSUNG: IVX000145048(P20H0279/US)

Title of Invention	SEMICONDUCTOR PACKAGE INCLUDING STACKED SEMICONDUCTOR CHIPS			
	As the below named inventor(s), I I The declaration is directed to:	nereby declare that:		
		or		
	☐ United States application PCT/KR####/##### filed or	or PCT international application number		
Declaration	The above-identified application wa	as made or authorized to be made by me.		
	I believe that I am the original or a application.	an original joint inventor of a claimed invention in the		
		willful false statement made in this declaration is fine or imprisonment of not more than five (5) years		
		ion of the sum of one dollar (\$1), the receipt whereof I valuable consideration, I, by these presents do sell, ee(s)		
		SK hynix Inc.		
	2091, Gyeongchung-dae	ero, Bubal-eub, Icheon-si, Gyeonggi-do,		
	R	epublic of Korea		
Assignment	and the heirs, successors, assigns and legal representatives of the assignee(s) the full and exclusive right to the said invention in the United States and in its territorial possessions and in any and all foreign countries any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States, I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee(s), of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.			
	I agree promptly upon request of the assignee(s), its heirs, successors, assigns and legal representatives of the assignee(s) to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney, Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary.			
	I hereby covenant that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.			
	I further covenant that assignee(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to me and will testify as to the same in any litigation related thereto and will promptly execute and deliver to assignee(s) or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.			
Legal Name Of Inventor	Inventor Name (First Middle LAST):	Jong Hyun KIM		
	Inventor Signature:	<u> </u>		
	Date:	21, 3, 26		

PATENT REEL: 055826 FRAME: 0207

RECORDED: 04/05/2021